



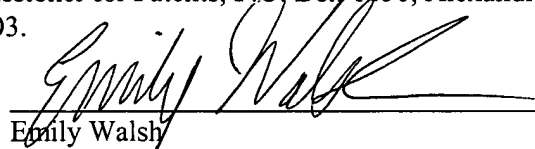
PATENT
Attorney Docket No. ASC-061

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S): Lochtefeld et al.
SERIAL NO.: 10/629,498 GROUP NO.: Not Yet Assigned
FILING DATE: July 29, 2003 EXAMINER: Not Yet Assigned
TITLE: SELECTIVE PLACEMENT OF DISLOCATION ARRAYS

CERTIFICATE OF FIRST CLASS MAILING UNDER 37 C.F.R. 1.8

I hereby certify that this correspondence, and any document(s) referred to as enclosed herein, is/are being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 31st day of October, 2003.


Emily Walsh

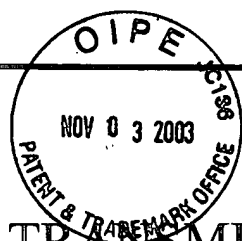
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Submitted herewith are:

1. Transmittal Form (1 pg.);
2. Supplemental Information Disclosure Statement (2 pgs.);
3. Supplemental Form PTO-1449 (7 pgs.);
4. Copies of Cited References (C4-C37);
5. Return Receipt Postcard; and this
6. Certificate of First Class Mailing (1 pg.).

2704414



TRANSMITTAL FORM

Application Serial Number	10/629,498
Filing Date	July 29, 2003
First Named Inventor	Lochtefeld
Group Art Unit	Not Yet Assigned
Examiner Name	Not Yet Assigned
Attorney Docket No.	ASC-061
Patent No.	Not Applicable
Issue Date	Not Applicable


ENCLOSURES (check all that apply)

<input type="checkbox"/> Fee Transmittal Form <input type="checkbox"/> Check Attached <input type="checkbox"/> Copy of Fee Transmittal Form	<input type="checkbox"/> Copy of Notice to File Missing Parts of Application	<input type="checkbox"/> Notice of Appeal to Board of Patent Appeals and Interferences
<input type="checkbox"/> Amendment/Response <input type="checkbox"/> Preliminary <input type="checkbox"/> After Final <input type="checkbox"/> Affidavits/declaration(s) <input type="checkbox"/> Letter to Official Draftsperson including Drawings [Total Sheets _____]	<input type="checkbox"/> Formal Drawings	<input type="checkbox"/> Appeal Brief (in triplicate)
<input type="checkbox"/> Petition for Extension of Time	<input type="checkbox"/> Request For Continued Examination (RCE) Transmittal	<input type="checkbox"/> Status Inquiry
<input checked="" type="checkbox"/> Supplemental Information Disclosure Statement <input checked="" type="checkbox"/> Supplemental Form PTO-1449 <input checked="" type="checkbox"/> Copies of IDS Citations (C4-C37)	<input type="checkbox"/> Power of Attorney (Revocation of Prior Powers)	<input checked="" type="checkbox"/> Return Receipt Postcard
<input type="checkbox"/> Certified Copy of Priority Document(s)	<input type="checkbox"/> Terminal Disclaimer	<input checked="" type="checkbox"/> Certificate of First Class Mailing under 37 C.F.R. 1.8
<input type="checkbox"/> Sequence Listing submission <input type="checkbox"/> Paper Copy/CD <input type="checkbox"/> Computer Readable Copy <input type="checkbox"/> Statement verifying identity of above	<input type="checkbox"/> Executed Declaration and Power of Attorney for Utility or Design Patent Application	<input type="checkbox"/> Certificate of Facsimile Transmission under 37 C.F.R. 1.8
	<input type="checkbox"/> Small Entity Statement	<input type="checkbox"/> Additional Enclosure(s) (please identify below)
	<input type="checkbox"/> CD(s) for large table or computer program	
	<input type="checkbox"/> Amendment After Allowance	
	<input type="checkbox"/> Request for Certificate of Correction <input type="checkbox"/> Certificate of Correction (in duplicate)	

CORRESPONDENCE ADDRESS

Direct all correspondence to: Patent Administrator
Testa, Hurwitz & Thibault, LLP
High Street Tower
125 High Street
Boston, MA 02110
Tel. No.: (617) 248-7000
Fax No.: (617) 248-7100

SIGNATURE BLOCK

Respectfully submitted,


Natasha C. Us
Attorney for the Applicants
Testa, Hurwitz & Thibault, LLP
High Street Tower
125 High Street
Boston, MA 02110

Date: October 31, 2003
Reg. No. 44,381
Tel. No.: (617) 310-8327
Fax No.: (617) 248-7100



PATENT
Attorney Docket No. ASC-061

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANTS: Lochtefeld et al.
SERIAL NO.: 10/629,498 GROUP NO.: Not Yet Assigned
FILING DATE: July 29, 2003 EXAMINER: Not Yet Assigned
TITLE: SELECTIVE PLACEMENT OF DISLOCATION ARRAYS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Sir:

In accordance with the provisions of 37 C.F.R. 1.97 and 1.98, Applicants hereby make of record the patents and publications listed on the accompanying Form PTO-1449, and other information contained herein, for consideration by the Examiner in connection with the examination of the above-identified patent application. Copies of the publications are enclosed.

REMARKS

In accordance with the provisions of 37 C.F.R. 1.97, this statement is being filed (CHECK ONE):

- ☒ (1) within three (3) months of the **filing date** of a national application other than a continued prosecution application under 37 C.F.R. 1.53(d), or within three (3) months of the **date of entry of the national stage** as set forth in 37 C.F.R. 1.491 in an international application, or before the mailing of the **first Office action** on the merits, or before the mailing of a **first Office action** after the filing of a request for continued examination under 37 C.F.R. 1.114; or
- ☐ (2) after the period defined in (1) but before the mailing date of a **final action** or a **notice of allowance** under 37 C.F.R. 1.311, and
- ☐ the requisite Statement is below, **OR**

- ☐ the requisite fee under 37 C.F.R. 1.17(p), namely **\$180.00**, is included herein,
or
- ☐ (3) after the mailing date of a **final action** or **notice of allowance** but before the
payment of the **issue fee**, **AND**
- ☐ the requisite Statement is below, **AND**
- ☐ the requisite petition fee under 37 C.F.R. 1.17(p), namely **\$180.00** is included
herein.

It is respectfully requested that each of the patents and publications listed on the attached
Form PTO-1449, and other information contained herein, be made of record in this application.

In addition, Applicants wish to inform the Examiner about the following co-pending
patent applications, including all Office actions issued therein:

U.S. Serial No. 10/264,935, filed on October 4, 2002, by Lochtefeld et al.

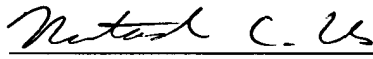
U.S. Serial No. 10/456,708, filed on June 6, 2003, by Lochtefeld et al.

U.S. Serial No. 10/456,103, filed on June 6, 2003, by Lochtefeld et al.

Respectfully submitted,

Date: October 31, 2003
Reg. No. 44,381

Tel. No.: (617) 310-8327
Fax No.: (617) 248-7100



Natasha C. Us
Attorney for the Applicants
Testa, Hurwitz, & Thibeault, LLP
High Street Tower
125 High Street
Boston, Massachusetts 02110

2703636



FORM PTO - 1449 SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT				ATTY DOCKET NO. ASC-061 APPLICANTS: Lochtefeld et al. SERIAL NO.: 10/629,498 FILING DATE: July 29, 2003 GROUP: Not yet assigned				
U.S. PATENT DOCUMENTS								
EXAM. INIT.	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE		
	A2	4,885,614	12/5/1989	Furukawa et al.				
	A3	5,032,893	7/16/1991	Fitzgerald et al.				
	A4	5,084,411	1/28/1992	Laderman et al.				
	A5	5,091,767	2/25/1992	Bean et al.				
	A6	5,156,995	10/20/1992	Fitzgerald et al.				
	A7	5,256,550	10/26/1993	Laderman et al.				
FOREIGN PATENT DOCUMENTS								
EXAM. INIT.	DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
OTHER ART, JOURNAL ARTICLES, ETC.								
EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)							
	C4	Akatsu et al., "Wafer bonding of different III-V compound semiconductors by atomic hydrogen surface cleaning," <u>Journal of Applied Physics</u> , Vol. 90, No. 8 (October 15, 2001), pp. 3856-3862.						
	C5	Belgal et al., "A New Mechanism of Pipeline Defect Formation in CMOS Devices," <u>International Reliability Physics Symposium</u> , (1994), pp. 399-404.						
	C6	Bulsara et al., "Relaxed InxGa1-xAs graded buffers grown with organometallic vapor phase epitaxy on GaAs," <u>Applied Physics Letters</u> , Vol. 72, No. 13 (March 30, 1998), pp. 1608-1610.						
	C7	Cullis et al., "Growth ripples upon strained SiGe epitaxial layers on Si and misfit dislocation interactions," <u>Journal of Vacuum Science and Technology</u> , A 12(4) (July/August 1994), pp. 1924-1931.						
	C8	Currie et al., "Carrier mobilities and process stability of strained Si n- and p-MOSFETs on SiGe virtual substrates," <u>Journal of Vacuum Science and Technology</u> , B 19(6) (November/December 2001), pp. 2268-2279.						
EXAMINER				DATE CONSIDERED				



FORM PTO - 1449				ATTY DOCKET NO. ASC-061					
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT				APPLICANTS: Lochtefeld et al.					
				SERIAL NO.: 10/629,498					
				FILING DATE: July 29, 2003					
				GROUP: Not yet assigned					
U.S. PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE		
	A8	5,323,031	6/21/1994	Shoji et al.					
	A9	5,659,187	8/19/1997	Legoues et al.					
	A10	5,801,085	9/1/1998	Kim et al.					
	A11	5,810,924	9/22/1998	Legoues et al.					
	A12	5,828,114	10/27/1998	Kim et al.					
	A13	5,937,274	8/10/1999	Kondow et al.					
FOREIGN PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
OTHER ART, JOURNAL ARTICLES, ETC.									
EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)								
	C9	De Boeck et al., "Growth and structural characterization of embedded InAsSb on GaAs-coated patterned silicon by molecular beam epitaxy," <u>Applied Physics Letters</u> , 58 (9) (March 4, 1991), pp. 928-930.							
	C10	Feenstra et al., "Scattering from strain variations in high-mobility Si/SiGe heterostructures," <u>Journal of Applied Physics</u> , 78 (10) (November 15, 1995), pp. 6091-6097.							
	C11	Fitzgerald et al., "Dislocation dynamics in relaxed graded composition semiconductors," <u>Materials Science and Engineering</u> , B67 (1999), pp. 53-61.							
	C12	Godbey et al., "A Si0.7Ge0.3 strained-layer etch stop for the generation of thin layer undoped silicon," <u>Applied Physics Letters</u> , 56 (4) (January 22, 1990), pp. 373-375.							
	C13	Gonzales et al., "Advantages of thin interfaces in step-graded buffer structures," <u>Materials Science and Engineering</u> , B44 (1997), pp. 41-45.							
EXAMINER					DATE CONSIDERED				



FORM PTO - 1449 SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT				ATTY DOCKET NO. ASC-061 APPLICANTS: Lochtefeld et al. SERIAL NO.: 10/629,498 FILING DATE: July 29, 2003 GROUP: Not yet assigned					
U.S. PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE		
	A14	6,576,532	6/10/2003	Jones et al.					
	A15	US 20020185686A	12/12/2002	Christiansen et al.					
FOREIGN PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
OTHER ART, JOURNAL ARTICLES, ETC.									
EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)								
	C14	Gray et al., "Effect of Anisotropic Strain on the Crosshatch Electrical Activity in Relaxed GeSi Films," <u>Physical Review Letters</u> , Vol. 86, No. 16 (April 16, 2001), pp. 3598-3601.							
	C15	Ha et al., "Anomalous Junction Leakage Current Induced by STI Dislocations and Its Impact on Dynamic Random Access Memory Devices," <u>IEEE Transactions on Electron Devices</u> , Vol. 46, No. 5 (May 1999), pp. 940-946.							
	C16	Knall et al., "The use of graded InGaAs layers and patterned substrates to remove threading dislocations from GaAs on Si," <u>Journal of Applied Physics</u> , 76 (5) (September 1, 1994), pp. 2697-2702.							
	C17	MacElwee et al., "High-Performance Fully Depleted Silicon-on-Insulator Transistors," <u>IEEE Transactions on Electron Devices</u> , Vol. 37, No. 6 (June 1990), pp. 1444-1451.							
EXAMINER				DATE CONSIDERED					



FORM PTO - 1449 SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT				ATTY DOCKET NO. ASC-061 APPLICANTS: Lochtefeld et al. SERIAL NO.: 10/629,498 FILING DATE: July 29, 2003 GROUP: Not yet assigned				
U.S. PATENT DOCUMENTS								
EXAM. INIT.	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE		
FOREIGN PATENT DOCUMENTS								
EXAM. INIT.	DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
OTHER ART, JOURNAL ARTICLES, ETC.								
EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)							
	C18	McCarthy et al., "Effect of threading dislocations on AlGaIn/GaN heterojunction bipolar transistors," <u>Applied Physics Letters</u> , Vol. 78, No. 15 (April 9, 2001), pp. 2235-2237.						
	C19	Meshkinpour et al., "Role of misfit dislocations on pseudomorphic high electron mobility transistor," <u>Applied Physics Letters</u> , 66 (6) (February 6, 1995), pp. 748-750.						
	C20	Mica et al., "Crystal defects and junction properties in the evolution of device fabrication technology," <u>Journal of Physics: Condensed Matter</u> , 14 (2002), pp. 13403-13410.						
	C21	Momose et al., "Dislocation-free and lattice-matched Si/GaP1-xNx/Si structure for photo-electronic integrated systems," <u>Applied Physics Letters</u> , Vol. 79, No. 25 (December 17, 2001), pp. 4151-4153.						
	C22	Mooney et al., "Scanning x-ray microtopographs of misfit dislocations at SiGe/Si interfaces," <u>Applied Physics Letters</u> , Vol. 79, No. 15 (October 8, 2001), pp. 2363-2365.						
EXAMINER				DATE CONSIDERED				



FORM PTO - 1449				ATTY DOCKET NO. ASC-061					
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT				APPLICANTS: Lochtefeld et al.					
				SERIAL NO.: 10/629,498					
				FILING DATE: July 29, 2003					
				GROUP: Not yet assigned					
U.S. PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE		
FOREIGN PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
OTHER ART, JOURNAL ARTICLES, ETC.									
EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)								
	C23	Mooney et al., "SiGe TECHNOLOGY: Heteroepitaxy and High-Speed Microelectronics," <u>Annual Review of Materials Science</u> , 30 (2000), pp. 335-362.							
	C24	Mooney et al., "Thermal Stability of Strained Si on Relaxed Si _{1-x} Gex Buffer Layers," <u>Materials Research Society Symposium Proceedings</u> , Vol. 686 (2002), pp. A1.2.1-A1.2.6.							
	C25	Morris et al., "Structure property anisotropy in lattice-mismatched single heterostructures," <u>Journal of Applied Physics</u> , 71 (5) (March 1, 1992), pp. 2321-2327.							
	C26	Ohashi et al., "Simulation of dislocation accumulation in ULSI cells with STI structure," <u>Applied Surface Science</u> , (2003), pp. 1-7.							
	C27	Rammohan et al., "Study of μm -scale spatial variations in strain of a compositionally step-graded In _x Ga _{1-x} GaAs(001) heterostructure," <u>Applied Physics Letters</u> , 66 (7) (February 13, 1995), pp. 869-871.							
EXAMINER					DATE CONSIDERED				



FORM PTO - 1449 SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT				ATTY DOCKET NO. ASC-061 APPLICANTS: Lochtefeld et al. SERIAL NO.: 10/629,498 FILING DATE: July 29, 2003 GROUP: Not yet assigned					
U.S. PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE		
FOREIGN PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
OTHER ART, JOURNAL ARTICLES, ETC.									
EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)								
	C28	Samavedam et al., "Novel dislocation structure and surface morphology effects in relaxed Ge/Si-Ge(graded)/Si structures," <u>Journal of Applied Physics</u> , 81 (7) (April 1, 1997), pp. 3108-3116.							
	C29	Sleight et al., "Stress Induced Defects and Transistor Leakage for Shallow Trench Isolated SOI," <u>IEEE Electron Device Letters</u> , Vol. 20, No. 5 (May 1999), pp. 248-250.							
	C30	Soh et al., "Relation Between Etch Pit Pairs And Pipeline Defects In CMOS Device," <u>International Reliability Physics Symposium</u> , pp. 244-248.							
	C31	Su et al., "Effects of Dislocation and Bulk Micro Defects on Device Leakage," SEMICON Taiwan 2001, pp. 1-4.							
	C32	Thompson et al., "NMOS Device Characteristics in Electron-Beam-Recrystallized SOI," <u>IEEE Transactions on Electron Devices</u> , Vol. 40, No. 7 (July 1993), pp. 1270-1276.							
EXAMINER					DATE CONSIDERED				



FORM PTO - 1449				ATTY DOCKET NO. ASC-061					
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT				APPLICANTS: Lochtefeld et al.					
				SERIAL NO.: 10/629,498					
				FILING DATE: July 29, 2003					
				GROUP: Not yet assigned					
U.S. PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE		
FOREIGN PATENT DOCUMENTS									
EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
OTHER ART, JOURNAL ARTICLES, ETC.									
EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)								
	C33	Tromp et al., "ADVANCES IN SITU ULTRA-HIGH VACUUM ELECTRON MICROSCOPY: Growth of SiGe on Si," <u>Annual Review of Materials Science</u> , 30 (2000), pp. 431-449.							
	C34	Wang et al., "PIPELINE DEFECTS IN CMOS MOSFET DEVICES CAUSED BY SWAMI ISOLATION," <u>International Reliability Physics Symposium</u> , (1992), pp. 85-90.							
	C35	Williams et al., "Evaluation of the Yield Impact of Epitaxial Defects on Advanced Semiconductor Technologies, 2000 IEEE/SEMI Advanced Semiconductor Manufacturing Conference, pp. 1-7.							
	C36	Wu, "Novel Etch-Stop Materials for Silicon Micromachining," Master of Science Thesis, Massachusetts Institute of Technology, 1997.							
	C37	Yamada et al., "Static analysis of off-axis crystal film growth onto a lattice-mismatched substrate," <u>Applied Physics Letters</u> , Vol. 79, No. 5 (July 30, 2001), pp. 608-610.							
EXAMINER					DATE CONSIDERED				